MOMENTIVE

Technical Data Sheet



TSE3854D

TSE3854D

Description

TSE3854D is a one-component silicone adhesive, which cures on exposure to atmospheric moisture to form a flame retardant silicone rubber. The product offers excellent corrosion-free adhesion to metals, including copper, plastics, ceramics, glass, etc without the use of primers.

Key Features and Benefits

PRODUCT FEATURES

- Flame retardant: certified UL94 V-0 => 3854D-G: 0.8 mm 3854D-W: 1.5 mm (UL file No. E56745)
- Non-corrosive to metals: meets MIL-A-46146B corrosion tests
- One component: easy to use
- Low odour cure: releases an alcohol vapour during cure
- Outstanding electrical properties
- Primerless adhesion to many substrates

Applications

Flame retardant adhesive sealant for TV parts and CRT, house appliances, communication equipment, instruments and gauges Moisture proof, waterproof, electrical insulation, vibration proof adhesive sealant for hybrid integrated circuits, sensors, high voltage electronic assemblies, printed circuit boards etc. General adhesion for metal, glass, plastics etc

Uncured PropertiesCure SystemAlkoxyColourGrey/WhiteConsistencyThixotropic PasteTack Free Time, minutes15Cured Properties1Specific Gravity, g/cm³1.32Hardness (Type A)40Tensile Strength, MPa2.7Elongation, %260Shear Strength Alu/Alu, MPa2.2Thermal Conductivity, W/(m.K)0.34Dielectric Constant (60 Hz)3.1Dissipation Factor (60 Hz)0.02Volume Resistivity, ohm.cm2.5x10 ¹⁴		
ColourGrey/WhiteConsistencyThixotropic PasteTack Free Time, minutes15Cured Properties15Specific Gravity, g/cm³1.32Hardness (Type A)40Tensile Strength, MPa2.7Elongation, %260Shear Strength Alu/Alu, MPa2.2Thermal Conductivity, W/(m.K)0.34Dielectric Strength, kV/mm25Dielectric Constant (60 Hz)3.1Dissipation Factor (60 Hz)0.02	Uncured Properties	
ConsistencyThixotropic PasteTack Free Time, minutes15Cured PropertiesSpecific Gravity, g/cm³1.32Hardness (Type A)40Tensile Strength, MPa2.7Elongation, %260Shear Strength Alu/Alu, MPa2.2Thermal Conductivity, W/(m.K)0.34Dielectric Strength, kV/mm25Dielectric Constant (60 Hz)3.1Dissipation Factor (60 Hz)0.02	Cure System	Alkoxy
Tack Free Time, minutes15Cured Properties1.32Specific Gravity, g/cm³1.32Hardness (Type A)40Tensile Strength, MPa2.7Elongation, %260Shear Strength Alu/Alu, MPa2.2Thermal Conductivity, W/(m.K)0.34Dielectric Strength, kV/mm25Dielectric Constant (60 Hz)3.1Dissipation Factor (60 Hz)0.02	Colour	Grey/White
Cured PropertiesSpecific Gravity, g/cm³1.32Hardness (Type A)40Tensile Strength, MPa2.7Elongation, %260Shear Strength Alu/Alu, MPa2.2Thermal Conductivity, W/(m.K)0.34Dielectric Strength, kV/mm25Dielectric Constant (60 Hz)3.1Dissipation Factor (60 Hz)0.02	Consistency	Thixotropic Paste
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Hardness (Type A)40Tensile Strength, MPa2.7Elongation, %260Shear Strength Alu/Alu, MPa2.2Thermal Conductivity, W/(m.K)0.34Dielectric Strength, kV/mm25Dielectric Constant (60 Hz)3.1Dissipation Factor (60 Hz)0.02	Cured Properties	
Tensile Strength, MPa2.7Elongation, %260Shear Strength Alu/Alu, MPa2.2Thermal Conductivity, W/(m.K)0.34Dielectric Strength, kV/mm25Dielectric Constant (60 Hz)3.1Dissipation Factor (60 Hz)0.02	Specific Gravity, g/cm ³	1.32
Elongation, %260Shear Strength Alu/Alu, MPa2.2Thermal Conductivity, W/(m.K)0.34Dielectric Strength, kV/mm25Dielectric Constant (60 Hz)3.1Dissipation Factor (60 Hz)0.02	Hardness (Type A)	40
Shear Strength Alu/Alu, MPa2.2Thermal Conductivity, W/(m.K)0.34Dielectric Strength, kV/mm25Dielectric Constant (60 Hz)3.1Dissipation Factor (60 Hz)0.02	Tensile Strength, MPa	2.7
Thermal Conductivity, W/(m.K)0.34Dielectric Strength, kV/mm25Dielectric Constant (60 Hz)3.1Dissipation Factor (60 Hz)0.02	Elongation, %	260
Dielectric Strength, kV/mm25Dielectric Constant (60 Hz)3.1Dissipation Factor (60 Hz)0.02	Shear Strength Alu/Alu, MPa	2.2
Dielectric Constant (60 Hz) 3.1 Dissipation Factor (60 Hz) 0.02	Thermal Conductivity, W/(m.K)	0.34
Dissipation Factor (60 Hz) 0.02	Dielectric Strength, kV/mm	25
	Dielectric Constant (60 Hz)	3.1
Volume Resistivity, ohm.cm 2.5x10 ¹⁴	Dissipation Factor (60 Hz)	0.02
	Volume Resistivity, ohm.cm	2.5x10 ¹⁴

Typical Physical Properties

Patent Status

Nothing contained herein shall be construed to imply the nonexistence of any relevant patents or to constitute a permission, inducement or

recommendation to practice any invention covered by any patent, without authority from the owner of the patent.

Product Safety, Handling and Storage

The shelf life will be indicated by the ' use before date' on the associated documents with a minimum of 6 months when stored in the original unopened containers below 27 °C.

Customers should review the latest Material Safety Data Sheet (MSDS) and label for product safety information, safe handling instructions, personal protective equipment if necessary, and any special storage conditions required for safety. MSDS are available at <u>www.momentive.com</u> or, upon request, from any Momentive Performance Materials (MPM) representative. For product storage and handling procedures to maintain the product quality within our stated specifications, please review Certificates of Analysis, which are available in the Order Center. Use of other materials in conjunction with MPM products (for example, primers) may require additional precautions. Please review and follow the safety information provided by the manufacturer of such other materials.

Processing Recommendations

Surface Preparation

Insure that surfaces to be sealed, coated or bonded are clean and free of grease, lubricating oils, release agents and dirt. To optimize fast cure and good adhesion, substrates must be thoroughly dry of cleaning solvents before applying the adhesive/ sealant. The adhesive/ sealant should be applied to one surface only. Wipe away excess uncured material with a clean cloth. After curing, removal of material is more difficult.

Bonding

This product offers primerless adhesion to many substrates including most plastics. Maximum adhesion is obtained 72 hours after full cure is obtained (2 mm thick specimen to an aluminum substrate).

Curing

This product cures at room temperature reacting with atmospheric moisture. Whenever possible, 25°C and 50% relative humidity should be provided. Higher temperature and humidity will cause faster cures while lower temperatures and lower humidity will slow the cure considerably. This product cures from the outside (outer skin) inward; therefore, cure rate is also dependent on the thickness of the material. It is not recommended to apply material thicker than 6mm.

Limitations

Customers must evaluate Momentive Performance Materials products and make their own determination as to fitness of use in their particular applications.

Availability

TSE3854D-W is available in 130 gram tubes and in 333ml cartridges.TSE3854D-G is available in 130 and 230 gram tubes and in 20 kg pails

Contact Information

For product prices, availability, or order placement, contact our customer service by visiting momentive.com/ContactSilicones.

For literature and technical assistance, visit our website at: www.momentive.com

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